# **Product Information**

## MLX75023

QVGA Time-of-Flight sensor for Automotive Applications

- 320 x 240 pixels
- 1/3" sensor format (4.8 x 3.6 mm<sup>2</sup>)
- High Ambient Light Robustness
- Spectral response range 800-900 nm
- Suitable for LED or laser illumination
- Demodulation up to 40 MHz
- Small glass BGA package
- Ambient temperature range -40 to +105 degC

#### Description

The MLX75023 is a QVGA (320 x 240 pixel) resolution optical Time-of-Flight (TOF) camera sensor. Combined with a modulated light source, this sensor is capable of measuring distance and reflectivity at full resolution. The high dynamic range DepthSense<sup>™</sup> pixels support up to 120 klux background light. The sensor is available in a chip scale glass BGA package and offers many integration possibilities.

The MLX75023 features 2 analog dual-ended outputs with 9 bit pixel row & 8 bit pixel column addressing up to 50 MHz. Two digital inputs control the DepthSense<sup>TM</sup> pixel demodulation, up to a frequency of 40 MHz. The remaining digital inputs are used to control the sensor integration and reset sequence. Supply rails of +3.3V and -3.3V should be provided to power the chip. MLX75023 engineering samples and reference application schematic are available on request.

#### The Most Cost-Effective Real-Time 3D Imaging Solution

Compared to other 3D imaging solutions available on the market, DepthSense<sup>™</sup> TOF sensors are most cost-effective, thanks to

- Standard CMOS process compatibility
- Compatibility with LED and laser illumination
- Inherently robust 3D imaging
- Scalability of resolution, range and field-of- view
- High frame rate
- Minimal post-processing





Wireless

Pressure Sensors

**Bus ICs** 

BLDC Motor Control ICs

Optoelectronic Sensors

#### **Features & Benefits**

- Full QVGA (320 x 240) pixel resolution in 1/3" format
- Small pixel size: 15 x 15 um<sup>2</sup>
- Ambient Light Robust up to 120 klux (camera specific) .
- Compatible with LED and laser illumination (800-900 nm range) •
- Demodulation up to 40 MHz •
- Sensor readout up to 50 MS/s •
- Available in 6.6 x 5.5 mm<sup>2</sup> glass BGA package
- AEC-Q100 -40° to +105° Qualified

### **Block Diagram**



**Bus ICs** 



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